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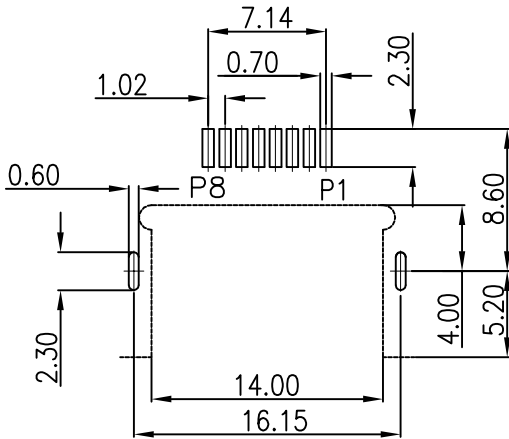
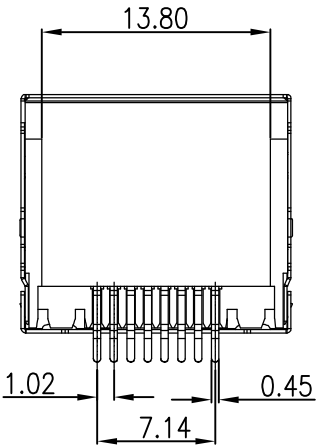
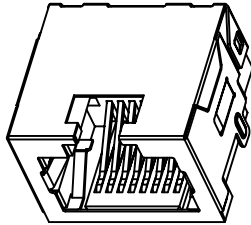
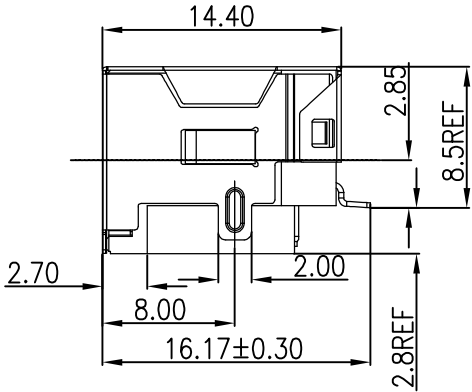
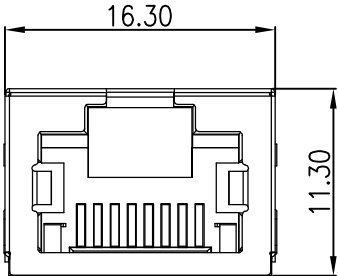
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NOTES

- MATERIAL
- 1.HOUSING MATERIAL : THERMO PLASTICS UL94V-0.
 - 2.CONTACT MATERIAL : PHOSPHOR BRONZE T=0.3.
 - 3.PLATING : GOLD PLATING ON CONTACT AREA TIN PLATED ON SOLDER AREA, NICKEL PLATD OVER ALL.
 - 4.SHIELD : BRASS T=0.20mm WITH NICKEL PLATED.
- ELECTRICAL
- 1.VOLTAGE RATING : 125 VAC RMS.
 - 2.CURRENT RATING : 1.5 AMP.
 - 3.CONTACT RESISTANCE : 40 MILLIOHMS MAX.
 - 4.INSULATION RESISTANCE : 500 MEGOHMS MIN @ 100V DC .
 - 5.DIELECTRIC DIELECTRIC RESISTANCE : 500V DC RMS 50Hz. 1MIN.

- MECHANICAL
- 1.DURRABILITY : 750 CYCLES MIN.
 - 2. MATING/UNMATING FORC: 2.24 KG.F MAX.

- ENVIRONMENTAL:
- 1.OPERATION : -40℃~+85℃.
 - 2.STORAGE : -40℃~+85℃.

3001 - 0 17 - X X

系列码
RJ45沉板
类别码
17:8.5铜壳

电镀码
1- GOLD FLASH
流水码
1:LCP黑 盘装
2:LCP黑 卷装

PCB LAYOUT
TOL:±0.05

				OPERATION		SCALE		Fit		Yxcon 东莞市宇熙精密连接器有限公司 www.yxcon.com Dongguan Yuxi Electronic Co.,Ltd.		
				X.X	±0.35	UNIT		MM				
				X.XX	±0.25	SIZE	A4	DESIGN	赵文品2024. 11. 06	PART NO	RJ45-3001-017-11	
				X.XXX	±0.05							
				Angle	±2°	SHEET	1/1	CHECK		TITLE	RJ45 沉板8.5 SMT有壳无灯GF LCP黑	
REV	DATE	SYMBOL	MODIFICATION DESCRIPTION	DIM	TOL	PROJ.		APPROVE		Customer No.		